

**AMENDMENTS TO THE CLAIMS**

1. (Currently Amended) An accessed object comprising a non-contact IC module including an IC chip and a radio communication antenna coil connected to said semiconductor device,

wherein said radio communication antenna coil is a continuous conductive wiring pattern bent to extend over two surfaces of different directions of said accessed object, and comprising a large and small module side antenna, the small module side antenna locating close to a first side edge, wherein said IC chip is inside the radio communication antenna coil.

2. (Currently Amended) An accessed object according to Claim 1, wherein said semiconductor device and said radio communication antenna coil are formed on a flexible sheet and said sheet is ~~bent substantially at a right angle and~~ attached to said accessed object.

3. (Original) An accessed object according to Claim 2, wherein a semiconductor device is provided in that position of said sheet which is away from the bent portion thereof.

4. (Previously Presented) An accessed object according to Claim 1, wherein said radio communication antenna coil is provided in the vicinity of a corner portion of the said accessed object.

5. (Previously Presented) An accessed body according to Claim 1, wherein said accessed object has a casing and said radio communication antenna coil is provided inside said casing.

6. (Original) An accessed object according to Claim 5, wherein said casing is opaque or translucent.

7. (Previously Presented) An accessed object according to Claim 1, wherein said accessed object is holding an information recording medium.

8-14. (Cancelled)